

December 2013

FPAM50LH60 PFC SPM[®] 2 Series for 2-Phase Interleaved PFC

Features

- UL Certified No.E209024 (UL1557)
- 600 V 50 A 2-Phase Interleaved PFC with Integral Gate Driver and Protection
- Very Low Thermal Resistance Using Al₂O₃ DBC Substrate
- Full-Wave Bridge Rectifier and High-Performance Output Diode
- Optimized for 20kHz Switching Frequency
- Built-in NTC Thermistor for Temperature Monitoring
- Isolation Rating: 2500 V_{rms}/min

Applications

2-Phase Interleaved PFC Converter

Related Source

<u>Will Be Released</u>

General Description

The FPAM50LH60 is a PFC SPM[®] 2 module providing a fully-featured, high-performance Interleaved PFC (Power Factor Correction) input power stage for consumer, medical, and industrial applications. These modules integrate optimized gate drive of the built-in IGBTs to minimize EMI and losses, while also providing multiple on-module protection features including under-voltage lockout, over-current shutdown, thermal monitoring, and fault reporting. These modules also feature a fullwave rectifier and high-performance output diodes for additional space savings and mounting convenience.



Fig. 1. Package Overview

Package Marking and Ordering Information

Device	Device Marking	Package	Packing Type	Quantity	
FPAM50LH60	FPAM50LH60	S32EA-032	Rail	8	

Integrated Drive, Protection and System Control Functions

- For IGBTs: gate drive circuit, Over-Current Protection (OCP), control supply circuit Under-Voltage Lock-Out (UVLO) Protection
- Fault signal: corresponding to OC and UV fault
- Built-in thermistor: temperature monitoring
- Input interface : active-HIGH interface, works with 3.3 / 5 V logic, Schmitt trigger input

Pin Configuration



Pin Number	Pin Name	Pin Description
1	C _{SC}	Signal Input for Over-Current Detection
2,6,10	СОМ	Common Supply Ground
3	V _{FO}	Fault Output
4	IN _X	PWM Input for X IGBT Drive
5	IN _Y	PWM Input for Y IGBT Drive
7	N.C	No Connection
8,9	V _{CC}	Common Supply Voltage of IC for IGBT Drive
11	R _{TH}	Series Resistor for The Use of Thermistor
12	V _{TH}	Thermistor Bias Voltage
13,14	N _R	Negative DC-Link of Rectifier Diode
15,16,17	N.C	No Connection
18,19	R	AC Input for R-Phase
20,21	N.C	No Connection
22,23	S	AC Input for S-Phase
24,25	Р	Output of Diode
26	P _Y	Input of Diode
27	N.C	No Connection
28	P _X	Input of Diode
29	X	Output of X Phase IGBT
30	Y	Output of Y Phase IGBT
31	N _P	Negative DC-Link of IGBT
32	P _R	Positive DC-Link of Rectifier Diode

Internal Equivalent Circuit



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Absolute Maximum Ratings (T_J = 25°C, unless otherwise specified.)

Converter Part

Symbol	Parameter	Conditions	Rating	Unit
V _i	Input Supply Voltage	Applied between R - S	264	V _{rms}
V _{PN}	Output Voltage	Applied between X - N _P , Y - N _P , P - P _X , P - P _Y	450	V
V _{PN(Surge)}	Output Supply Voltage (Surge)	Applied between X - N _P , Y - N _P , P - P _X , P - P _Y	500	V
V _{CES}	Collector-emitter Voltage	Breakdown Voltage between X - N _P , Y - N _P	600	V
V _{RRM}	Repetitive Peak Reverse Voltage of FRD	Breakdown Voltage between P - P _X , P - P _Y	600	V
V _{RRMR}	Repetitive Peak Reverse Voltage of Rec- tifier	Breakdown Voltage between $P_R - R$, $P_R - S$, R - N_R , S - N_R	900	V
*I _F	FRD Forward Current	T _C = 25°C, T _J < 125°C	50	А
*I _{FSM}	Peak Surge Current of FRD	Non-Repetitive, 60 Hz Single Half-Sine Wave	500	А
*I _{FR}	Rectified Forward Current	T _C = 25°C, T _J < 125°C	50	А
*I _{FSMR}	Peak Surge Current of Rectifier	Non-Repetitive, 60 Hz Single Half-Sine Wave	500	А
± *I _C	Each IGBT Collector Current	T _C = 25°C, T _J < 125°C	50	А
± *I _{CP}	Each IGBT Collector Current(Peak)	$T_C = 25^{\circ}C, T_J < 125^{\circ}C,$ Under 1 ms Pulse Width	100	А
*P _C	Collector Dissipation	T _C = 25°C per IGBT	135	W
Τ _J	Operating Junction Temperature	(1st Note 1)	-40 ~ 125	°C

1st Notes:

1. The maximum junction temperature rating of the power chips integrated within the PFC $\text{SPM}^{\textcircled{B}}$ product is 125°C.

2. Marking "*" is calculation value or design factor.

Control Part

Symbol	Parameter	Conditions	Rating	Unit
V _{CC}	Control Supply Voltage	Applied between V _{CC} - COM	20	V
V _{IN}	Input Signal Voltage	Applied between IN _X , IN _Y - COM	$-0.3 \sim V_{CC} + 0.3$	V
V _{FO}	Fault Output Supply Voltage	Applied between V _{FO} - COM	$-0.3 \sim V_{CC} + 0.3$	V
I _{FO}	Fault Output Current	Sink Current at V _{FO} Pin	1	mA
V _{SC}	Current Sensing Input Voltage	Applied between C _{SC} - COM	-0.3 ~ V _{CC} + 0.3	V

Total System

Symbol	Parameter	Conditions	Rating	Unit
T _{STG}	Storage Temperature		-40 ~ 125	°C
V _{ISO}	Isolation Voltage	60 Hz, Sinusoidal, AC 1 Minute, Connect Pins to Heat-Sink Plate	2500	V _{rms}

Thermal Resistance

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
R _{th(j-c)Q}	Junction to Case Thermal	Each IGBT under Operating Condition	-	-	0.74	°C/W
R _{th(j-c)D}	Resistance	Each Diode under Operating Condition	-	-	1.13	°C/W
R _{th(j-c)R}		Each Rectifier under Operating Condition	-	-	0.74	°C/W

Electrical Characteristics (T_J = 25°C, unless otherwise specified.)

Converter Part

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{CE(SAT)}	IGBT Saturation Voltage	$V_{CC} = 15 \text{ V}, V_{IN} = 5 \text{ V}, I_{C} = 50 \text{ A}$	-	1.7	2.2	V
V _{FF}	FRD Forward Voltage	I _F = 50 A	-	1.9	2.4	V
V _{FR}	Rectifier Forward Voltage	I _{FR} = 50 A	-	1.13	1.35	V
I _{RR}	Switching Characteristic	$V_{PN} = 400 \text{ V}, V_{CC} = 15 \text{ V}, I_{C} = 25 \text{ A},$	-	27	-	А
t _{RR}		$V_{IN} = 0 V \leftrightarrow 5 V$, Inductive Load (1st Note 3), per IGBT	-	45	-	ns
t _{ON}			-	772	-	ns
t _{OFF}			-	1117	-	ns
t _{C(ON)}			-	110	-	ns
t _{C(OFF)}			-	125	-	ns
I _{CES}	Collector - Emitter Leakage Current	V _{CES} = 600 V	-	-	250	μΑ

1st Notes:

3. t_{ON} and t_{OFF} include the propagation delay of the internal drive IC. t_{C(ON)} and t_{C(OFF)} are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Figure 4.



Figure 4. Switching Time Definition

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erleaved PFC

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
IQCC	Quiescent V _{CC} Supply Current	V_{CC} = 15 V, IN _X , IN _Y - COM = 0 V, Supply current between V _{CC} and COM	-	-	2.65	mA
I _{PCC}	Operating V _{CC} Supply Current	V_{CC} = 15 V, f_{PWM} = 20 kHz, Duty = 50% Applied to One PWM Signal Input per IGBT Supply Current between V_{CC} and COM	-	-	7.0	mA
V _{FOH}	Fault Output Voltage	$V_{SC} = 0 \text{ V}, \text{ V}_{FO} \text{ Circuit: } 10 \text{ k}\Omega \text{ to } 5 \text{ V} \text{ Pull-up}$	4.5	-	-	V
V _{FOL}		V_{SC} = 1 V, V_{FO} Circuit: 10 k Ω to 5 V Pull-up	-	-	0.5	V
V _{SC(Ref)}	Over-Current Protection Trip Level Voltage of CSC Pin	V _{CC} = 15 V	0.45	0.5	0.55	V
UV _{CCD}	Supply Circuit Under-	Detection Level	10.5	-	13.0	V
UV _{CCR}	Voltage Protection	Reset Level	11.0	-	13.5	V
t _{FOD}	Fault-Out Pulse Width		30	-	-	μS
V _{IN(ON)}	ON Threshold Voltage	Applied between IN _X , IN _Y - COM	2.6	-	-	V
V _{IN(OFF)}	OFF Threshold Voltage	Applied between IN _X , IN _Y - COM	-	-	0.8	V
R _{TH}	Resistance of Thermistor	at T _{TH} = 25°C (1st Note 4, Figure 5)	-	47	-	kΩ
		at T _{TH} = 100°C (1st Note 4, Figure 5)	-	2.9	-	kΩ

1st Notes:

4. T_{TH} is the temperature of thermister itself. To know case temperature (T_C), please make the experiment considering your application.



R-T Curve

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
N.			197	.,,,,,	252	V
v _i			107	-	200	v rms
Ι _i	Input Current	I _C < 100°C, V _i = 220 V, V _O = 360 V, f _{PWM} = 20 kHz per IGBT	-	-	21	A _{rms}
V _{PN}	Supply Voltage	Applied between X - N _P , Y - N _P , P - P _X , P - P _Y	-	-	400	V
V _{CC}	Control Supply Voltage	Applied between V _{CC} - COM	13.5	15.0	16.5	V
dV _{CC} /dt	Supply Variation		-1	-	1	V/µs
I _{FO}	Fault Output Current	Sink Current at V _{FO} Pin	-	-	1	mA
f _{PWM}	PWM Input Frequency	-40°C < T _J < 125°C per IGBT	-	20	-	kHz

Recommended Operating Conditions (T_J = 25°C, unless otherwise specified.)

Mechanical Characteristics and Ratings

Parameter	Co	Conditions		Тур.	Max.	Unit
Mounting Torque	Mounting Screw: M4	Recommended 0.98 N•m	0.78	0.98	1.17	N•m
		Recommended 10 kg•cm	8	10	12	kg•cm
Device Flatness	See Figure 6	See Figure 6		-	+150	μm
Weight			-	32	-	g



Figure 6. Flatness Measurement Position





2nd Notes:

- 1. To avoid malfunction, the wiring of each input should be as short as possible(less than 2 ~ 3 cm).
- 2. V_{FO} output is open-drain type. This signal line should be pulled up to the positive-side of the MCU or control power supply with a resistor that makes I_{FO} up to 1 mA. 3. Input signal is active-HIGH type. There is a 5 ko resistor inside the IC to pull-down each input signal line to GND. RC coupling circuits is recommanded for the prevention of input signal oscillation. R_FC_F constant should be selected in the range 50~150ns (recommended R_F = 100 Ω , C_F = 1 nF).
- 4. To prevent error of the protection function, the wiring related with R_{SCF} and C_{SCF} should be as short as possible.
- 5. In the over current protection circuit, please select the R_{SCF} , C_{SCF} time constant in the range 1.5 ~ 2 $\mu s.$ 6. Each capacitors should be mounted as close to the PFC SPM® product pins as possible.
- 7. Relays are used at almost every systems of electrical equipments of home appliances. In these cases, there should be sufficient distance between the MCU / controller and the relays.
- 8. Internal NTC thermistor can be used for monitoring of the case temperature and protecting the device from the overheating operation. Select an appropriate resistor RT according to the application.
- 9. It is recommended that anti-parallel diode (D_X, D_Y) be connected with each IGBT.



http://www.fairchildsemi.com/dwg/MO/MOD32BA.pdf

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